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Application Da	ta Shoot 37	Sheet 37 CFR 1.76		torney Docket Number			UNIU40.017APC			
Application De	Olieet 37	J. K 1.76	Application Number							
Title of Invention	POLISHING P	AD AND SEM	ICONDUC	TOR DEVIC	E MANUF	ACTUR	ING METHOD			
bibliographic data arran	iged in a format sp completed electri	ecified by the Un onically and sub	ited States mitted to th	Patent and Ti	ademark O	office as o	omitted. The following form contains utlined in 37 CFR 1.76. g the Electronic Filling System (EFS			
Secrecy Order 37 CFR 5.2										
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Applicant Info	ormation:									
Applicant 1							Remove			
	Applicant Authority Inventor Clegal Representative under 35 U.S.C. 117 Party of Interest under 35 U.S.C. 118									
Prefix Given Na	ne	M	iddle Na	me		_	y Name	Suffix		
Tetsuo							OMURA			
Residence Inform	nation (Select		Residenc	, 0	on US Re	sidency	Active US Military Service			
City Ohtsu-shi		_	try Of Re	sidencei	JP					
Citizenship unde		b)i JP								
Mailing Address										
Address 1	_	O BOSEKI KAI	BUSHIKI I	KAISHA RE	SEARCH (CENTER				
Address 2	,	ata 2-chome								
	shi, Shiga				te/Provir	nce				
Postal Code	520-029	2		Country	JP					
Applicant 2							Remove			
Applicant Author	ity Inventor	OLegal Rep	resentativ	e under 35	U.S.C. 11	7 (Party of Interest under 35 U.S.	C. 118		
Prefix Given Na	ne	M	iddle Na	me		Famil	y Name	Suffix		
Masahiko						NAKA				
Residence Inform	nation (Select		Residenc	, 0	on US Re	sidency	Active US Military Service			
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City Ohtsu	shi, Shiga			Sta	te/Provir	nce				
Postal Code	520-029	2		Country	JP					
Applicant 3							Remove			
Applicant Author	ity • Inventor	OLegal Rep	xesentativ	e under 35	U.S.C. 11	7	Party of Interest under 35 U.S.	C. 118		
Prefix Given Na	ne '	M	iddle Na	me		Famil	v Name	Suffix		

Country Of Residence

YAMADA

Takatoshi

Ohtsu-shi

Residence Information (Select One) US Residency

Application Data Sheet 37 CFR				Attorney Docket Number			UNIU40.017APC		
Appli	cation Data	1.70	Application Number						
Title of	Invention Po	DLISHING PAD	AND SEM	IICONDUCT	TOR DEVICE	MANUF	FACTURII	NG METHOD	
Citizer	ship under 37	CFR 1.41(b) i	JP						
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Addre	ss 1	c/o TOYO BO	SEKI KA	ABUSHIKI K	AISHA RESI	EARCH (CENTER		
Addre	ss 2	1-1, Katata 2	-chome						
City	Ohtsu-shi,	Shiga			State	e/Provir	nce		
Postal Code 520-0292 Country JP									
Applic	ant 4	-						Remove	
Applic	ant Authority	Inventor (Legal Re	presentative	under 35 U	J.S.C. 11	7 (Party of Interest under 35 U.S.	C. 118
	Given Name		N	liddle Nan	ne		Family	Name	Suffix
	Kazuyuki		\neg				OGAW	Α	
Resid	ence Information	on (Select One) () US	S Residency	(a) No	n US Re	sidency	Active US Military Service	
City	Osaka-shi		Cour	ntry Of Res	sidencei	JP			
Citizer	ship under 37	CFR 1.41(b) i	JP						
Mailin	g Address of A	oplicant:	_						
Addre	ss 1	c/o TOYO TI	RE & RU	BBER CO.,	LTD.				
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Application Number

UNIU40.017APC

Title of Inve	Title of Invention POLISHING PAD AND SEMICONDUCTOR DEVICE MANUFACTURING METHOD											
Mailing Add	dress of	Applic	ant:									
Address 1		G	6 TOYO TIRE & RU	BBER CO.,	LTD.						_	
Address 2		1	7-18, Edobori 1-chome, Nishi-ku									
City	Osaka-sh	i, Osal	a			State	Province					
Postal Cod	le	5	50-8661		Cour	ntryi	JP	_				
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Customer I	Number		20995									
Email Addr	ess								Add E	mail	R	emove Email
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Title of the	Inventio	n	POLISHING PAD	AND SEMIC	CONDL	JCTOF	R DEVICE MANU	FAC	TURING	METH	OD	
Attorney D	ocket Nu	mber	UNIU40.017APC Small Entity Status Claimed									
Application	Туре		Nonprovisional									
Subject Ma	tter		Utility									
Suggested	Class (if	any)				St	ub Class (if an	7)				
Suggested	Technol	ogy C	enter (if any)									
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Publication	Informa	tion:										
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and ce	Request Not to Publish. I hereby request that the attached application not be published under \$3 U.S.C. 122(b) and order that the invention datacked in the attached application has not been and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing.											

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Application Data Sheet 37 CFR 1.76

Representative information should be provided for all practitioners having a power of attorney in the application. Providing this information in the Application Data Sheet does not constitute a power of attorney in the application (see 37 CFR 1 32). Enter either Customer Number or complete the Representative Name section below. If both sections are completed the Customer Number will be used for the Representative Information during processing. Please Select One: Customer Number US Patent Practitioner ○ US Representative (37 CFR 11.9) Customer Number 20995

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Application Data Sheet 37 CFR 1.76		Attorney Docket Number	UNIU40.017APC			
		Application Number				
Title of Invention	POLISHING PAD AND SEMI	MICONDUCTOR DEVICE MANUFACTURING METHOD				

Domestic Priority Information:

This section allows for the applicant to claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c). Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a)

(4), and need not otherwise be made part of the specification.					
Prior Application Status			Remove		
Application Number	Continuity Type	Prior Application Number	Filing Date (YYYY-MM-DD)		
	a 371 of international	PCT/JP2004/015480	2004-10-20		
Additional Domestic Priori the Add button.	ty Data may be generated within	n this form by selecting	Add		

Foreign Priority Information:

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a).

		Re	move
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed
2004-069423	JP	2004-03-11	Yes ○ No
		Re	move
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed
2004-069498	JP	2004-03-11	● Yes ○ No
Additional Foreign Priority Add button.	Data may be generated with	nin this form by selecting the	Add

Assignee Information:

Providing this information in the application data sheet does not substitute for compliance with any requirement of part 3 of Title 37

of the CFK to have an assignment recorded in the Onice.								
Assignee 1								
If the Assignee is an Organization check here.								
Prefix	Given Name	Middle Name	Family Name	Suffix				
Mailing Address I	nformation:		•	•				
Address 1								
Address 2								
City		State	/Province					
Country i		Post	al Code					
Phone Number		Fax	Number					
Email Address	mail Address							
Additional Assigne	ditional Assignee Data may be generated within this form by selecting the Add							

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١	Application Data Sheet 37 CFR 1.76		Attorney Docket Number	UNIU40.017APC	
			Application Number		
	Title of Invention	POLISHING PAD AND SEMI	CONDUCTOR DEVICE MANUF	FACTURING METHOD	

			required in accordance with	37 CFR 1.33 and 10.18.	Please see 37
Signature	/KOA43315/	Date (YYYY-MM-DD)	2006-09-08		
Circl Manne	Martin Alian	Last Massa	Anni	Desistantian Number	4224E

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